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<ul> <li>Qualified for Automotive Applications</li> <li>Operating Range 2-V to 5.5-V V<sub>CC</sub></li> </ul>	D OR PW PACKAGE (TOP VIEW)					
<ul> <li>Unbuffered Outputs</li> </ul>	1A 🛛 1					
<ul> <li>Latch-Up Performance Exceeds 250 mA Per JESD 17</li> </ul>	1Y [ 2 2A [ 3	13 6A 12 6Y				
ESD Protection Exceeds JESD 22	2Y 🛿 4	11 🛛 5A				
– 2000-V Human-Body Model (A114-A)	3A 🛛 5	10 <b>5</b> Y				
<ul> <li>200-V Machine Model (A115-A)</li> </ul>	3Y 🛛 6	9 🛛 4A				
<ul> <li>1000-V Charged-Device Model (C101)</li> </ul>	GND 7	8 4Y				

#### description/ordering information

The SN74AHCU04 device contains six independent inverters. This device performs the Boolean function  $Y = \overline{A}$ . Internal circuitry consists of single-stage inverters that can be used in analog applications such as crystal oscillators.

#### **ORDERING INFORMATION<sup>†</sup>**

TA	PACKA	ge‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING
40%C to 125%C	SOIC – D	Tape and reel	SN74AHCU04QDRQ1	AHCU04Q
–40°C to 125°C	TSSOP – PW	Tape and reel	SN74AHCU04QPWRQ1	AHCU04Q

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

<sup>‡</sup>Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

FUNCTION TABLE (each inverter)									
INPUT OUTPUT A Y									
Н	L								
L	н								

#### logic diagram (positive logic)





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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

$ \begin{array}{llllllllllllllllllllllllllllllllllll$	.5 V to 7 V CC + 0.5 V 20 mA ±20 mA ±25 mA ±50 mA 86°C/W
Storage temperature range, T <sub>stg</sub> 65°C	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		$V_{CC} = 2 V$	1.7		
VIH	High-level input voltage	$V_{CC} = 3 V$	2.4		V
		V <sub>CC</sub> = 5.5 V	4.4		
		$V_{CC} = 2 V$		0.3	
VIL	Low-level input voltage	$V_{CC} = 3 V$		0.6	V
		V <sub>CC</sub> = 5.5 V		1.1	
VI	Input voltage		0	5.5	V
VO	Output voltage		0	VCC	V
		$V_{CC} = 2 V$		-50	μA
lон	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	
		$V_{CC} = 5 V \pm 0.5 V$		-8	mA
		$V_{CC} = 2 V$		50	μA
IOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	
			8	mA	
TA	Operating free-air temperature		-40	125	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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PARAMETER	TEST CONDITIONS	Vcc	т	λ = 25°C	;	T <sub>A</sub> = −40°C TO 125°C		T <sub>A</sub> = −40°C TO 85°C		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
		2 V	1.8	2		1.8		1.8		
	I <sub>OH</sub> = -50 μA	3 V	2.7	3		2.7		2.7		
VOH		4.5 V	4	4.5		4		4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.3		2.4		
	I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.5		3.65		
		2 V			0.2		0.2		0.2	
	I <sub>OL</sub> = 50 μA	3 V			0.3		0.3		0.3	
VOL		4.5 V			0.5		0.5		0.5	V
	I <sub>OL</sub> = 4 mA	3 V			0.36		0.5		0.44	
	I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.5		0.44	
lı	V <sub>I</sub> = 5.5 V or GND	0 V to 5.5 V			±0.1		±1		±1	μA
ICC	$V_{I} = V_{CC} \text{ or GND},  I_{O} = 0$	5.5 V			2		20		20	μA
Ci	$V_I = V_{CC}$ or GND	5 V		2	10				10	pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	Тŗ	∖ = 25°C	;	T <sub>A</sub> = - TO 12		T <sub>A</sub> = TO 8		UNIT
	(INPUT)	(001901)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH		V	C <sub>L</sub> = 15 pF		5	7.1	1	10.5	1	8.5	
<sup>t</sup> PHL	A	Y		CL = 15 pF		5	7.1	1	10.5	1	8.5
<sup>t</sup> PLH	А	v	C <sub>I</sub> = 50 pF		7.5	10.6	1	14	1	12	20
<sup>t</sup> PHL	A	ſ	CL = 50 pr		7.5	10.6	1	14	1	12	ns

switching characteristics over recommended operating free-air temperature range,  $V_{CC}$  = 5 V  $\pm$  0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	Тŗ	ע = 25°C	;	T <sub>A</sub> = - TO 12		T <sub>A</sub> = - TO 8	40°C 5°C	UNIT												
	(INPUT)	(001P01)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX													
<sup>t</sup> PLH		v	0 45 55		3.5	5.5	1	8.5	1	6.5													
<sup>t</sup> PHL	A	ř	Ŷ	ř	Ŷ	Ŷ		ř	ř	ř	ř	C <sub>L</sub> = 15 pF	CL = 15 pF				3.5	5.5	1	8.5	1	6.5	ns
<sup>t</sup> PLH	^	v			5	7	1	11	1	9													
<sup>t</sup> PHL	A	ř	C <sub>L</sub> = 50 pF		5	7	1	11	1	9	ns												



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## noise characteristics, $V_{CC}$ = 5 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 4)

	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic V <sub>OL</sub>		0.5		V
V <sub>OL(V)</sub>	Quiet output, minimum dynamic V <sub>OL</sub>		-0.5		V
VOH(V)	Quiet output, minimum dynamic V <sub>OH</sub>		4.3		V
VIH(D)	High-level dynamic input voltage	4			V
VIL(D)	Low-level dynamic input voltage			1	V

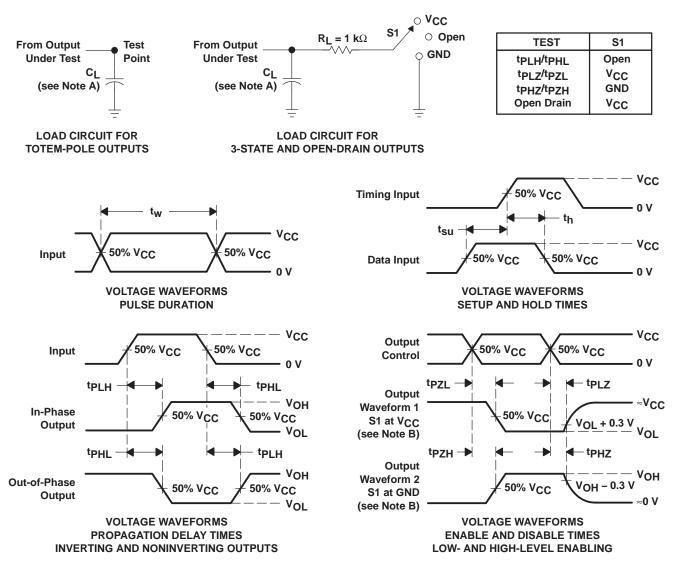
NOTE 4: Characteristics are for surface-mount packages only.

## operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST C	ONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load,	f = 1 MHz	7.3	pF



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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms





10-Dec-2020

### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	e Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AHCU04QPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AHCU04Q	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(<sup>6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN74AHCU04-Q1 :



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## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### Catalog: SN74AHCU04

• Enhanced Product: SN74AHCU04-EP

• Military: SN54AHCU04

NOTE: Qualified Version Definitions:

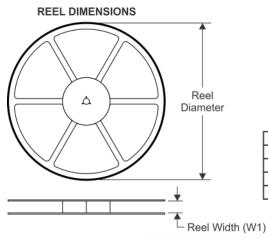
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

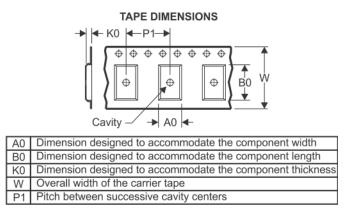
## PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHCU04QPWRG4Q 1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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## PACKAGE MATERIALS INFORMATION

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AHCU04QPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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